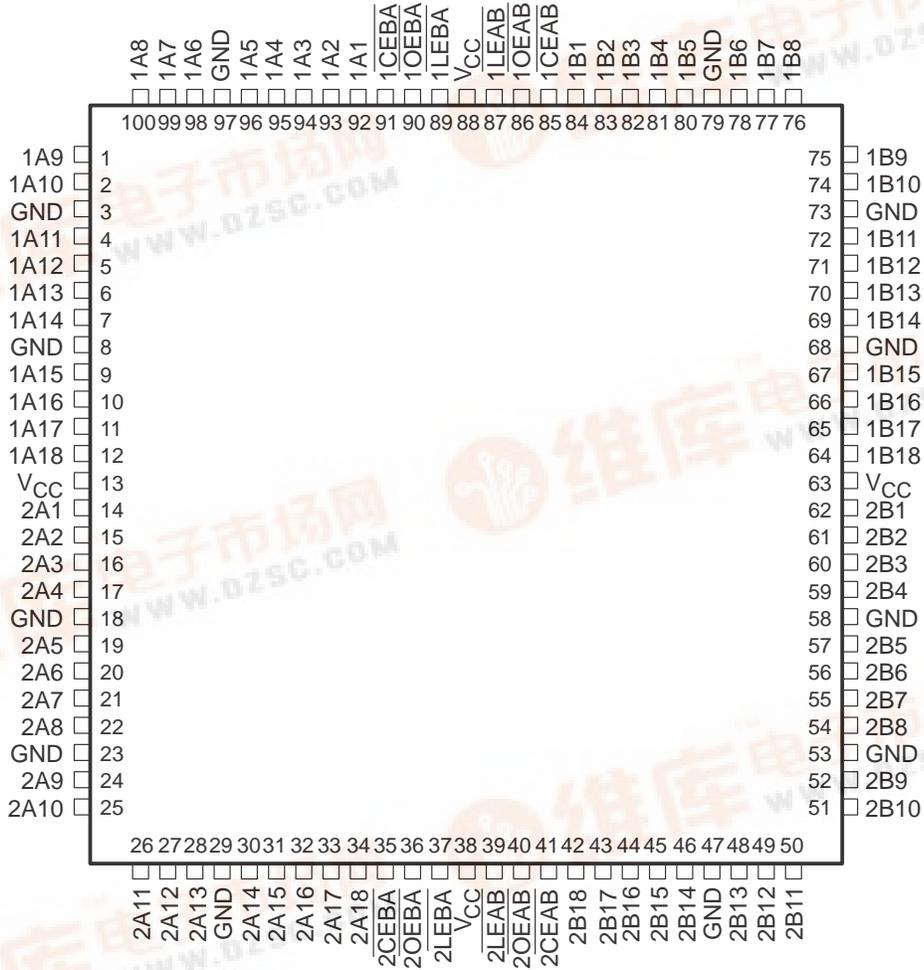


SN54ABTH32543, SN74ABTH32543 36-BIT REGISTERED BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS230F – JUNE 1992 – REVISED MAY 1997

- Members of the Texas Instruments *Widebus+*™ Family
- State-of-the-Art *EPIC-II B*™ BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- High-Impedance State During Power Up and Power Down
- Released as DSCC SMD 5962-9557801NXD
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- High-Drive Outputs (–32-mA I_{OH} , 64-mA I_{OL})
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include 100-Pin Plastic Thin Quad Flat (PZ) Package With 14 × 14-mm Body Using 0.5-mm Lead Pitch and Space-Saving 100-Pin Ceramic Quad Flat (HS) Package†

'ABTH32543 . . . PZ PACKAGE
(TOP VIEW)



† The HS package is not production released.



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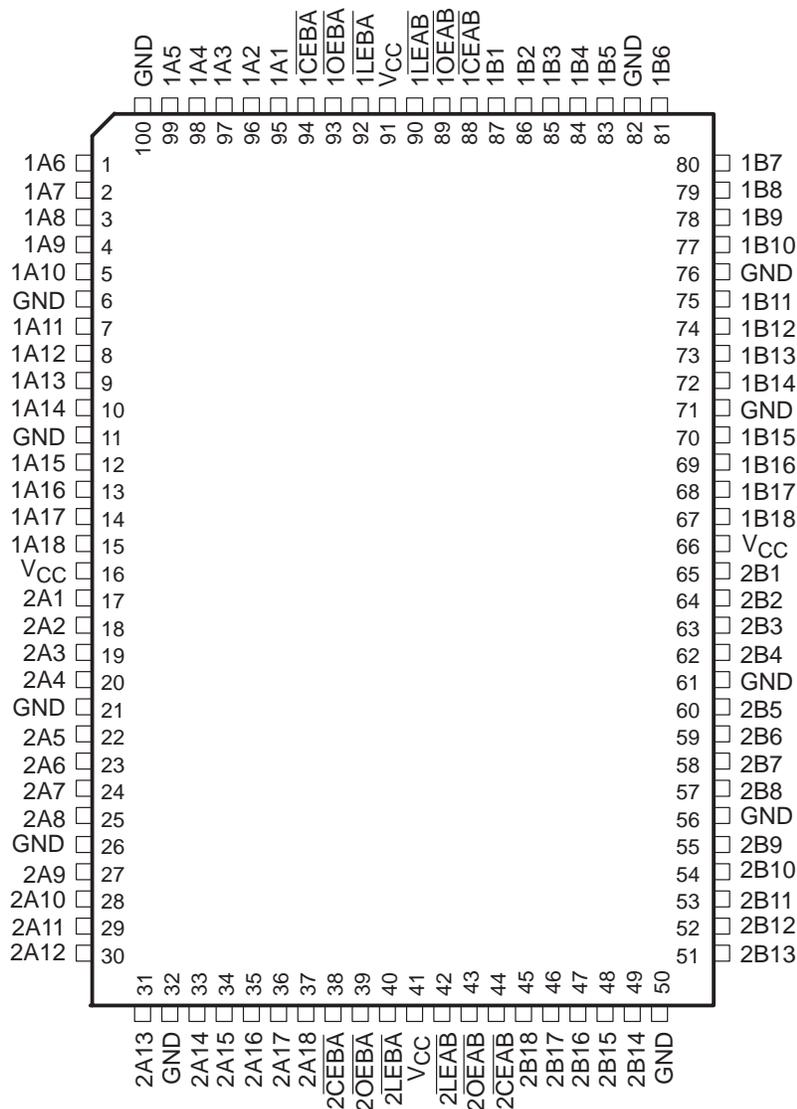
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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SN54ABTH32543 . . . HS PACKAGE†
(TOP VIEW)



† For HS package availability, please contact the factory or your local TI Field Sales Office.

description

The 'ABTH32543 are 36-bit registered transceivers that contain two sets of D-type latches for temporary storage of data flowing in either direction. These devices can be used as two 18-bit transceivers or one 36-bit transceiver. Separate latch-enable (\overline{LEAB} or \overline{LEBA}) and output-enable (\overline{OEAB} or \overline{OEBA}) inputs are provided for each register to permit independent control in either direction of data flow.

The A-to-B enable (\overline{CEAB}) input must be low to enter data from A or to output data from B. If \overline{CEAB} is low and \overline{LEAB} is low, the A-to-B latches are transparent; a subsequent low-to-high transition of \overline{LEAB} puts the A latches in the storage mode. With \overline{CEAB} and \overline{OEAB} both low, the 3-state B outputs are active and reflect the data present at the output of the A latches. Data flow from B to A is similar but requires using the \overline{CEBA} , \overline{LEBA} , and \overline{OEBA} inputs.

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description (continued)

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN54ABTH32543 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABTH32543 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE†
(each 18-bit section)

INPUTS				OUTPUT B
$\overline{\text{CEAB}}$	$\overline{\text{LEAB}}$	$\overline{\text{OEAB}}$	A	
H	X	X	X	Z
X	X	H	X	Z
L	H	L	X	B_0^{\ddagger}
L	L	L	L	L
L	L	L	H	H

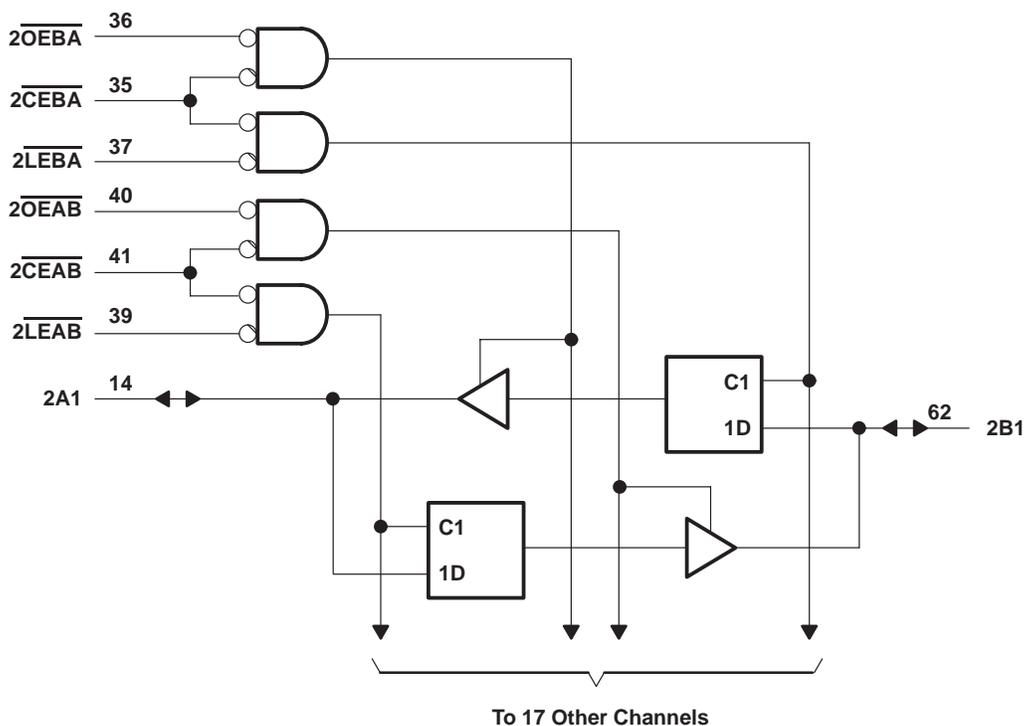
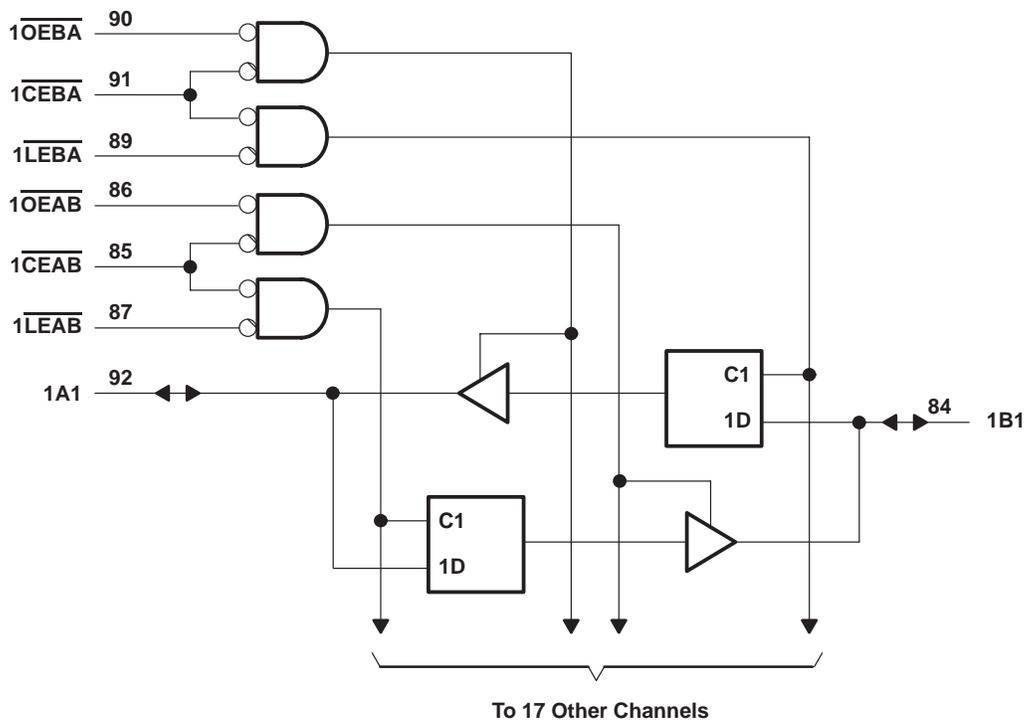
† A-to-B data flow is shown; B-to-A flow control is the same except that it uses $\overline{\text{CEBA}}$, $\overline{\text{LEBA}}$, and $\overline{\text{OEBA}}$.

‡ Output level before the indicated steady-state input conditions were established

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logic diagram (positive logic)



Pin numbers shown are for the PZ package.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (except I/O ports) (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, V_O	–0.5 V to 5.5 V
Current into any output in the low state, I_O : SN54ABTH32543	96 mA
SN74ABTH32543	128 mA
Input clamp current, I_{IK} ($V_I < 0$)	–18 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Package thermal impedance, θ_{JA} (see Note 2): PZ package	50°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

recommended operating conditions (see Note 3)

		SN54ABTH32543		SN74ABTH32543		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage	2		2		V
V_{IL}	Low-level input voltage		0.8		0.8	V
V_I	Input voltage	0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current		–24		–32	mA
I_{OL}	Low-level output current		48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate		10		10	ns/V
	Outputs enabled					
$\Delta t/\Delta V_{CC}$	Power-up ramp rate	200		200		μ s/V
T_A	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: Unused control pins must be held high or low to prevent them from floating.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	SN54ABTH32543			SN74ABTH32543			UNIT	
		MIN	TYP†	MAX	MIN	TYP†	MAX		
V _{IK}	V _{CC} = 4.5 V, I _I = -18 mA			-1.2			-1.2	V	
V _{OH}	V _{CC} = 4.5 V, I _{OH} = -3 mA	2.5			2.5			V	
	V _{CC} = 5 V, I _{OH} = -3 mA	3			3				
	V _{CC} = 4.5 V								
V _{OL}	V _{CC} = 4.5 V	I _{OL} = -24 mA						V	
		I _{OL} = -32 mA					2		
V _{OL}	V _{CC} = 4.5 V	I _{OL} = 48 mA					0.55	V	
		I _{OL} = 64 mA					0.55		
V _{hys}			100			100		mV	
I _I	Control inputs	V _{CC} = 0 to 5.5 V, V _I = V _{CC} or GND					±1	μA	
	A or B ports	V _{CC} = 2.1 V to 5.5 V, V _I = V _{CC} or GND					±20		
	Control inputs	V _{CC} = 5.5 V, V _I = V _{CC} or GND					±1		
	A or B ports						±20		
I _I (hold)	A or B ports	V _{CC} = 4.5 V	V _I = 0.8 V				100	μA	
			V _I = 2 V				-100		
I _{OZPU} ‡	V _{CC} = 0 to 2.1 V, V _O = 0.5 V to 2.7 V, $\overline{OE} = X$			±50			±50	μA	
I _{OZPD} ‡	V _{CC} = 2.1 V to 0, V _O = 0.5 V to 2.7 V, $\overline{OE} = X$			±50			±50	μA	
I _{off}	V _{CC} = 0, V _I or V _O ≤ 4.5 V						±100	μA	
I _{CEX}	V _{CC} = 5.5 V, V _O = 5.5 V	Outputs high		50			50	μA	
I _O §	V _{CC} = 5.5 V, V _O = 2.5 V		-50	-100	-180	-50	-100	-180	mA
I _{CC}	V _{CC} = 5.5 V, I _O = 0, V _I = V _{CC} or GND	Outputs high		3			3	mA	
		Outputs low		20			20		
		Outputs disabled		2			2		
ΔI _{CC} ¶	V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND			1			1	mA	
C _i	Control inputs	V _I = 2.5 V or 0.5 V		3.5			3.5	pF	
C _{io}	A or B ports	V _O = 2.5 V or 0.5 V		9.5			9.5	pF	

† All typical values are at V_{CC} = 5 V, T_A = 25°C.

‡ This parameter is specified by characterization.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

		V _{CC} = 5 V, T _A = 25°C#		SN54ABTH32543		SN74ABTH32543		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
t _w	Pulse duration, \overline{LEAB} or \overline{LEBA} low	3.3		3.3		3.3		ns
t _{su}	Setup time	Data before \overline{LEAB} ↑ or \overline{LEBA} ↑	2.1		2.6		2.1	ns
		Data before \overline{CEAB} ↑ or \overline{CEBA} ↑	1.7		2		1.7	
t _h	Hold time	Data after \overline{LEAB} ↑ or \overline{LEBA} ↑	0.6		1.1		0.6	ns
		Data after \overline{CEAB} ↑ or \overline{CEBA} ↑	0.9		1.2		0.9	

These limits apply only to the SN74ABTH32543.

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

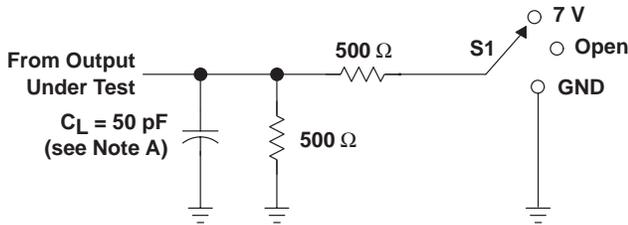
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5$ V, $T_A = 25^\circ\text{C}^\dagger$			SN54ABTH32543		SN74ABTH32543		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A or B	B or A	1	3.5	5.2	0.5	6.3	1	5.9	ns
t_{PHL}			1	3.5	5.1	0.5	5.9	1	5.7	
t_{PLH}	\overline{LE}	A or B	1.9	4.6	6.3	0.8	7.9	1.9	7.5	ns
t_{PHL}			1.9	4.3	5.9	0.8	6.9	1.9	6.6	
t_{PZH}	\overline{CE}	A or B	1.7	4.3	6.7	0.8	8.3	1.7	8	ns
t_{PZL}			2.6	5.2	8	1	8.8	2.6	8.8	
t_{PHZ}	\overline{CE}	A or B	1.6	3.8	6.6	0.5	7.4	1.6	7.1	ns
t_{PLZ}			2.4	4.6	7	1	7.9	2.4	7.5	
t_{PZH}	\overline{OE}	A or B	1.4	3.8	6.1	0.5	7.6	1.4	7.3	ns
t_{PZL}			2.3	4.7	7.4	1	8.2	2.3	8.1	
t_{PHZ}	\overline{OE}	A or B	1.3	3.4	6.1	0.5	6.7	1.3	6.5	ns
t_{PLZ}			2	4.2	6.6	0.8	7.2	2	6.9	

[†] These limits apply only to the SN74ABTH32543.

SN54ABTH32543, SN74ABTH32543 36-BIT REGISTERED BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

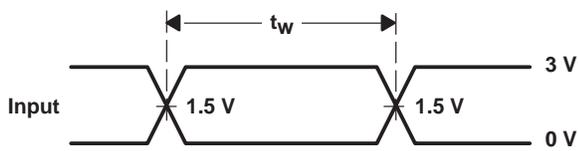
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PARAMETER MEASUREMENT INFORMATION

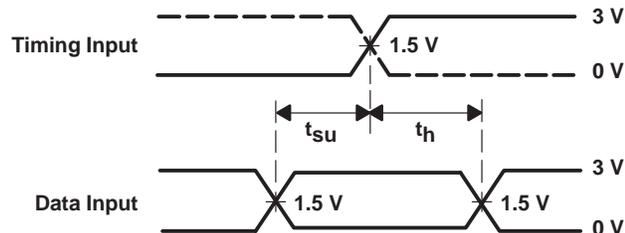


LOAD CIRCUIT

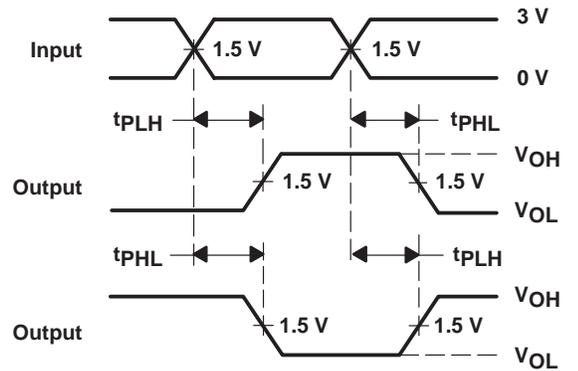
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	Open



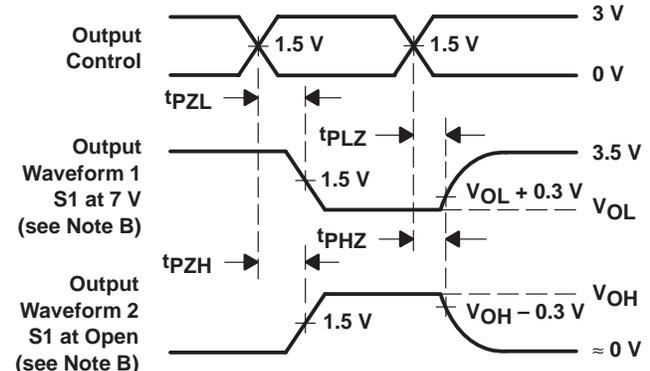
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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